198. (New) A method of coating a substrate using a coating apparatus having a conveying surface, the method comprising the steps of:

applying a base coat layer to the substrate, said substrate being said conveying surface of the coating apparatus;

applying an active coating material to the base coat layer to form an active coating layer, the active coating material comprising biologically active material; and

applying a cover coating layer over the active coating layer, the three layers being removable together by peeling from the substrate in the form of a three-layer wafer, the base coat layer and the cover coating layer each being applied electrostatically as a powder and each being fused to form a film; and

removing the active coating layer as said three-layer wafer comprising the active coating layer.

199. (New) A method of coating a substrate using a coating apparatus having a conveying surface, the method comprising the steps of:

applying an active coating material to the substrate to form an active coating layer, said substrate being said conveying surface of the coating apparatus, the active coating material comprising biologically active material, wherein the active coating layer is removable from the substrate as a wafer comprising the active coating layer;

supporting the substrate adjacent to a source of the active coating material with a surface of the substrate being maintained at such a different electric potential from that of the active coating material that the application of the electric potential causes the active coating material to move from the source of the active coating material towards

F5

\*\* BROWN et al Serial No. 09/310,740

the substrate, whereby a surface of the substrate becomes coated with the active coating material.